

# SID

Factory: Rot am See

Article:

761

ML4

Provided:

Customer:

Date:



Processtechnology: B: undefiniert

Material Text	Mat. Nr.	µm	Stackup	Process overview
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A-RS Kupferfolie-009my 330x490mm

9

VS

1

A-RS-FR4-Prepreg-1080-TG150-HF

60

2

A-RS-FR4-ML-0.51mm-035+035-TG150-HF

35

L2

3

510

35

L3

A00

B00

A-RS-FR4-Prepreg-1080-TG150-HF

60

4

A-RS Kupferfolie-009my 330x490mm

9

RS

5

Thickness after Pressing

B00:

690 µm

Tol+:

80 µm

Tol-:

80 µm

Dmax:

770 µm

Dmin:

610 µm

Thickness over all

0 µm

Tol+:

0 µm

Tol-:

0 µm

Dmax:

0 µm

Dmin:

0 µm

Demand for customer

Thickness (D):

800 µm

Tol+:

80 µm

Tol-:

80 µm

Dmax:

880 µm

Dmin:

720 µm

Measuring point: (05) über LM und galv.Cu; beidseitig

nominal:

718 µm

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